CXA1779P

Predriver for High Resolution Computer Displays

Description

The CXA1779P is a bipolar IC developed for high resolution computer displays.

Features

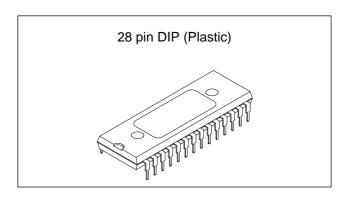
- Wide bandwidth (150MHz/-3dB typ.)
- RGB single package
- Permits RGB common and independent contrast control
- Permits RGB independent pedestal level control
- Input D-range: 0.7Vp-p (min.)

Applications

High resolution computer displays

Structure

Bipolar silicon monolithic IC



Absolute Maximum Ratings

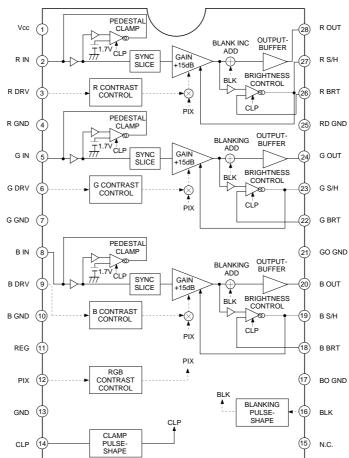
•	Supply voltage	Vcc	14	V
•	Operating temperature	Topr	-20 to +75	°C
•	Storage temperature	Tstg	-65 to +150	°C
•	Allowable power dissipation	PD	2.8	W

Recommended Operating Conditions

Supply voltage Vcc 12 ± 0.6 V

Block Diagram and Pin Configuration

(Top View)



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Pin Description

Pin No.	Symbol	Pin voltage	Equivalent circuit	Description	
1	Vcc	12V		Power supply pin.	
2	R IN		Vcc200μA	RGB input pins.	
5	G IN	3.0V	2 5 8 A 129	The pedestal level of the input signal is 3.0V during clamping. Connect 0.01µF in series as	
8	BIN		(8) Δ 129 1 200μA GND	the clamping capacitor.	
3	R DRV		Vcc	RGB contrast adjustment	
6	G DRV		W 60k	pins. The variable range of the pin	
9	B DRV	_	3 + 1/29	3 voltages is nom (voltages is from 0 to 5V.
12	PIX		9 A (12) GND	RGB simultaneous contrast adjustment pin. The variable range of the pin voltage is from 0 to 5V.	
4	R GND			OND 1 () 1	
7	G GND	0V		GND pins for the input amplifier block.	
10	B GND				
11	REG	5V	Vcc 11	 Internal regulator stabilizing pin. 5V regulator output pin. Attaches the decoupling capacitance (0.01µF). 	
13	GND	0V		GND pin.	
17	BO GND				
21	GO GND	0V		GND pins for the output stage buffer amplifier block.	
25	RO GND			,	

Pin No.	Symbol	Pin voltage	Equivalent circuit	Description
14	CLP	_	Vcc 129 \$\begin{align*}	 Clamp pulse input pin. Turns the input clamp and the bright level adjustment circuit on and off when high. VH = 3V VL = 1.5V
15	N.C.	_		Leave this pin open. Connect to GND.
16	BLK	_	Vcc	Blanking pulse input pin. Threshold level at approximately 2.25V. VH = 3V VL = 1.5V
18	B BRT		Vcc200μA200μA	
22	G BRT	_	18 W 50k	RGB bright level adjustment pins. The variable range of the pin voltages is from 0 to 5V.
26	R BRT		(22) (26) A (SND	
19	B S/H		Vcc \$	
23	G S/H		19 23 27	Pins to externally attach the sample-and-hold capacitor (0.01µF).
27	R S/H		GND 200μA 100μA	
20	B OUT		Vcc	
24	G OUT		20 24	RGB output pins.
28	R OUT		(24) (28) GND	

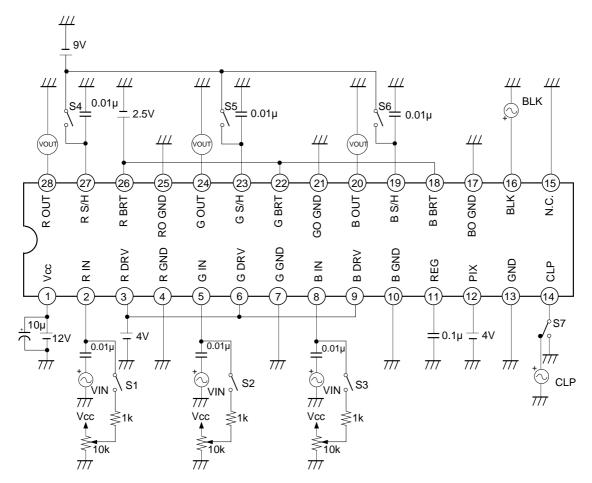
Electrical Characteristics

(Ta = 25°C, Vcc = 12V, See Electrical Characteristics Measurement Circuit.)

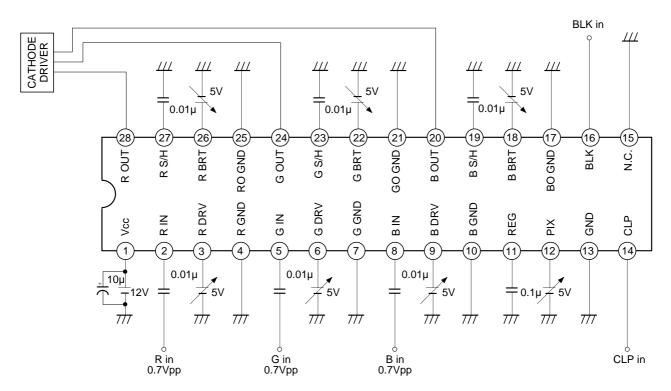
No.	Item	Symbol	Measurement contents	Min.	Тур.	Max.	Unit
1	Current consumption	Icc	S1 to S7: OFF Input signal: None	50	88	120	mA
2	Frequency response	f100MHz	S1 to S7: ON Input continuous 1MHz and 100MHz sine waves at 0.7Vp-p, and measure the gain difference of the output amplitudes. Gain difference [dB] = 20log (Vout 100M) RGB input signal (RGB input pin) RGB input Signal (RGB input pin) CLP potential	-3	-1.5	_	dB
3	Contrast control	CONTMAX	S1 to S7: OFF Input video signal 0.7Vp-p and measure output signal amplitude Vout. Calculate the contrast gain from this Vout. CONTMAX [dB] = $20log\left(\frac{Vout}{0.7}\right)$ RGB input signal 0.7Vpp Measuring is possible with or without a sync signal.	13	14	_	dB
	Brightness	BRTmax	S1 to S7: OFF CLP pulse width: 300ns Measure the pedestal level of the RGB output signal. RGB output signal	— 3.5	3.5	_	V
4	BRTmin Pedestal level GND Measuring is possible with or without a sync signal.	_	1.9	_	V		
5	Sub contrast gain	DRVgain	S1 to S7: OFF Input video signal 0.7Vp-p and measure the variable width of output signal Vout. Gain difference [dB] = 20log (Vout DRVmin Vout DRVmax) RGB output signal DRVmax DRVmin Measuring is possible with or without a sync signal.	_	-6	_	dB

No.	Item	Symbol	Measurement contents	Min.	Тур.	Max.	Unit
6	Input D-range	D rang	S1 to S7: OFF Measure the level which maintains the output gain when the input video signal level is varied.	_	0.8		Vp-p
7	Minimum clamp pulse width	CLPmin	S1 to S7: OFF Measure the clamp pulse width where the pedestal level of output signal Vout does not fluctuate. Video input Pulse width CLP pulse	_	300	_	ns

Electrical Characteristics Measurement Circuit



Application Circuit



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Description of Operation

1. Contrast control

The contrast for RGB IN (Pins 2, 5 and 8) input signals is adjusted using a DC externally input to the PIX pin (Pin 12). In addition, the contrast for each RGB channel can be adjusted independently using a DC externally input to the DRV pins (Pins 3, 6 and 9). (See Graphs 1 and 2.)

2. Pedestal clamp and brightness control

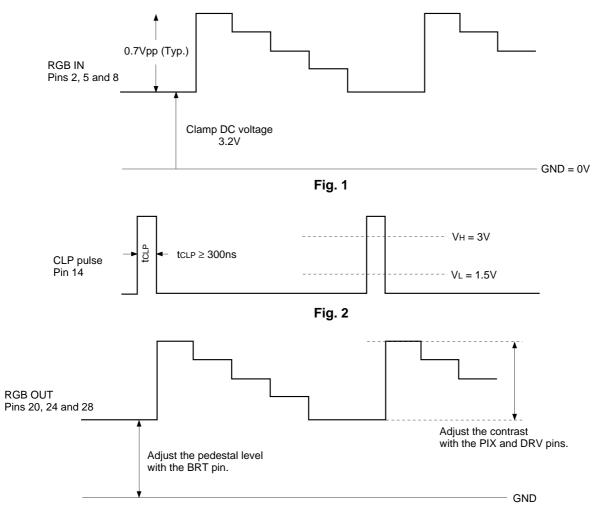
The pedestal clamp clamps the pedestal level when the CLP pin (Pin 14) is high. The RGB IN pin voltage at the pedestal is approximately 3.2V when the pedestal is clamped. The CLP pin threshold level is 3V for VH and 1.5V for VL. (See Fig. 2.)

Using a DC externally input to the R, G and B BRT pins (Pins 26, 22 and 18), the brightness control samples and holds the pedestal with the capacitance connected to the RGB SH pins (Pins 27, 23 and 19) when the CLP pin (Pin 14) is high, thereby adjusting the pedestal level of the R, G and B channels. (See Graph 3.)

3. Blanking additional function

Output is blanked when the BLK pin (Pin 16) is high. The BLK pin threshold level is 3V for V_H and 1.5V for V_L. See the Example of Input/Output Signals for output signal levels. The output signal is 0.3V during the blanking interval. (See Figs. 4 and 5.)

Example of Input/Output Signals



When a sync signal is added to the RGB input signal, after the signal is sliced into approximately 60mVp-p inside the IC, it is amplified by the gain from the PIX and DRV pins and output.

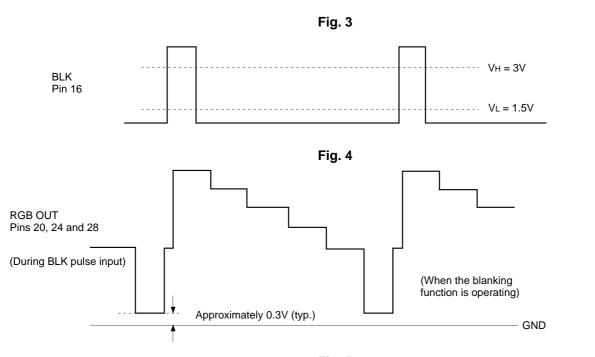
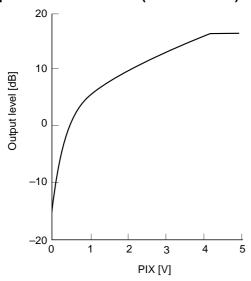


Fig. 5

Example of Representative Characteristics

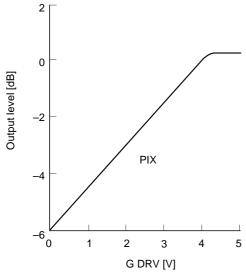
Graph 1. Contrast control (RGB common) characteristics



Input conditions for each control pin

Р	in name	Pin vo	Pin voltage		
12	PIX	0 to 5	[V]		
3	R DRV	4	[V]		
6	G DRV	4	[V]		
9	B DRV	4	[V]		
26	R BRT	2.5	[V]		
22	G BRT	2.5	[V]		
18	B BRT	2.5	[V]		
5	G IN	0.65 [Vpp]		

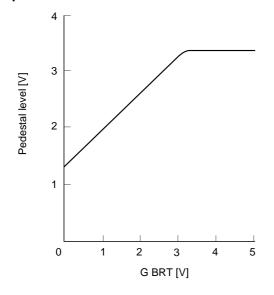
Graph 2. DRV control (RGB independent) characteristics (Gch)



Input conditions for each control pin

Р	in name	Pin vol	in voltage		
12	PIX	4	[V]		
3	R DRV	4	[V]		
6	G DRV	0 to 5	[V]		
9	B DRV	4	[V]		
26	R BRT	2.5	[V]		
22	G BRT	2.5	[V]		
18	B BRT	2.5	[V]		
5	G IN	0.65 [Vpp]		

Graph 3. BRT control characteristics

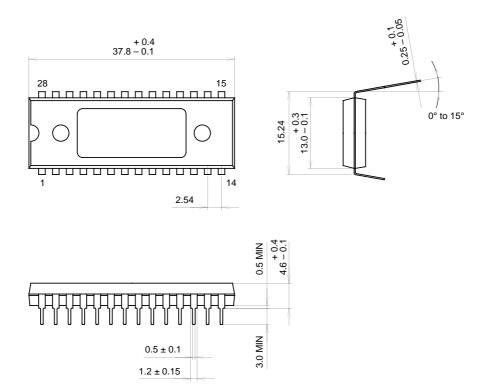


Input conditions for each control pin

Р	in name	Pin vol	tage
12	PIX	2.5	[V]
3	R DRV	2.5	[V]
6	G DRV	2.5	[V]
9	B DRV	2.5	[V]
26	R BRT	2.5	[V]
22	G BRT	0 to 5	[V]
18	B BRT	2.5	[V]
5	GIN	0.65 [Vpp]

Package Outline Unit: mm

28PIN DIP (PLASTIC) 600mil



PACKAGE STRUCTURE

SONY CODE	DIP-28P-03
EIAJ CODE	*DIP028-P-0600-C
JEDEC CODE	

PACKAGE MATERIAL	EPOXY RESIN
LEAD TREATMENT	SOLDER PLATING
LEAD MATERIAL	COPPER
PACKAGE WEIGHT	4.2g